

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: W1903-01	 l(R1)	DATE:	5-Apr-2019	MEANS OF DISTIN	GUISHING CHANG	GED DEVICES:			
Product Affected: P	-Jun-2019		•	☐ Product Mark ☐ Back Mark ☐ Date Code ■ Other	Traceability to the I provided through th lot code on the date mark.	Fab location is e 2 digit sequential			
Contact: IDT	PCN DESK			Attachment:	Yes	□ No			
	desk@idt.com				tact your local sales				
DESCRIPTION AND PURPOSE OF CHANGE:									
 □ Die Technology □ Wafer Fabrication P □ Assembly Process □ Equipment □ Material □ Testing ■ Manufacturing Site □ Data Sheet □ Other 	Process in T a a T T F S	Revision 1: That nadvertently This notificate alternate Four This is to proper is no clearly There is also sheet.	missed out in the ion is to advise address for the provide additional thange to the product Fab 8.	N notice is to add the one original PCN notice our customers that ID ducts listed on this normanufacturing capacit duct design or process a package, backend much fication report.	e. PCN effective date T has qualified TSM tice. ty for these products s technology as the e	e remains unchanged. IC Fab 6 as an			
RELIABILITY/QUAI	LIFICATION S	UMMARY:							
Based on wafer and component level qualification to date and characterization tests, there is no change to the performance or reliability of the product.									
CUSTOMER ACKNOWLEDGMENT OF RECEIPT:									
IDT records indicate the to grant approval or recit will be assumed that IDT reserves the right on the earlier version has	hat you require wind this change is account to ship either vers	ritten notificanformation. Iceptable.	ation of this char If IDT does not	receive acknowledger	ment within 30 days	of this notice			
Customer:			_ 🗆	Approval for s	hipments prior to	o effective date.			
Name/Date: E-			Mail Address:						
Title: Pl		none# /Fax# :							
CUSTOMER COMMENTS:									
IDT ACKNOWLEDGMENT OF RECEIPT:									
RECD. BY:				DATE:					



Qualification Report

Product Type: IDTP9221S-0 (Wireless Power Receiver/Transmitter) – Fab 6

Device Family:AW694TProcess Technology:CM018BCD, 1P4M

Package Type:AHG52 (WLCSP52)Fab Location:TSMC Fab 6

Test Description	Standard	Test Conditions	Sample Size	Reject	Comments
Device Characterization	IDT's datasheet condition		80	0	Pass
ESD: Human Body Model	JESD22-A114 (JS-001) Classification – 1B	1 KV	3	0	Pass 1KV
ESD: Charged Device Model	JESD22-C101 Classification – C1	500 V	3	0	Pass 500V
Latch-Up	JESD78	+/-100mA I/O and 1.5x Vcc OV stress, Class II (85°C)	3	0	Pass
Early Life Failure Rate (ELFR)	JESD22-A108, JESD74	48 hrs. @ 125 °C, Vcc = 11V	3 x 834	0	Pass
High Temperature Operating Life (HTOL)	JESD22-A108, +125°C, Vcc-max	1,000 hrs. @ 125 °C, Vcc =11V	3 x 77	0	Pass
High Temperature Storage (HTS)	JESD22-A103	150°C, 1000 hrs	3 x 77	0	Pass
Temperature Cycling (TC)	JESD22-A113, JESD22- A104	Cond. B55°C to 125°C, 700 cyc	3 x 77	0	Pass
Unbiased Highly Accelerated Stress Test (UHAST)	JESD22-A113, JESD22- A118	Unbiased, 130°C/85%	3 x 77	0	Pass